

Microsystems Prototyping

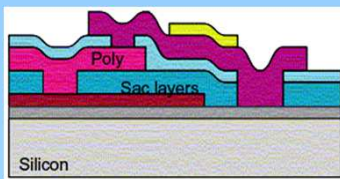
Bulk Micromachining

Post Process on austriamicrosystems 0.35µ CMOS process 650 euro / mm² + 3700 euro

Specific MEMS Technologies

These technologies allow the realization of various MEMS devices.

→ PolyMUMPS

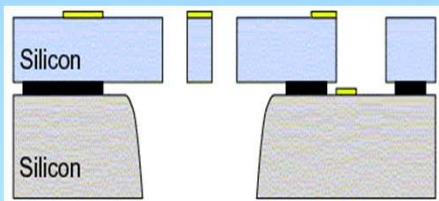


Polysilicon / gold
Surface micromachining

from MEMSCAP

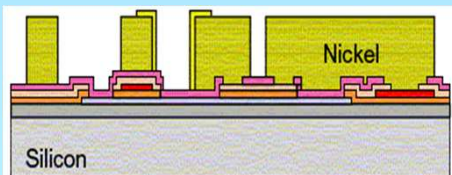


→ SOIMUMPS



Deep Reactive Ion Etching
on Silicon On Insulator

→ MetalMUMPS Nickel electroplated



Price for 15 prototypes:
3700 \$ for Education and Research,
4600 \$ for Industry. 1cm x 1cm (fixed size)

CAD, design kits and support

CMP distributes several MEMS CAD tool solutions from SoftMEMS. In addition, CMP distributes design kits for the MEMS technologies and for most of the CAD tools. Some specific support is given to CMP customers for MEMS design.

Contact

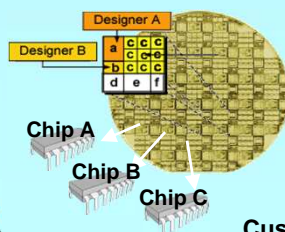
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Customers

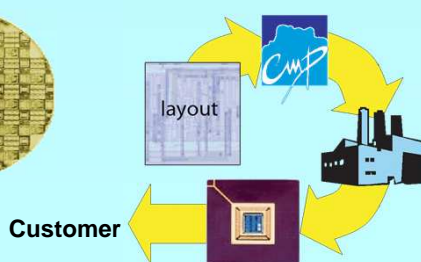
750 Universities and Research laboratories, 270 Industrial Companies from 70 countries, have already participated.



Multi Project Wafer (MPW)



MPW Cycle Time



Integrated Circuits and MEMS

CMOS, BiCMOS, SiGe, HV, GaAs, MEMS, MUMPS, 3D, FDSOI from



Jun. 2011